

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	23	("3652442" "3743590" "3963588" "4102756" "4267024" "4279707" "4304641" "4359375" "4364801" "4500394"). PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 15:30
L3	10	("3652442" "3743590" "3963588" "4102756" "4267024" "4279707" "4304641" "4359375" "4364801" "4500394"). PN.	US-PGPUB; USPAT	OR	ON	2006/02/16 15:30
S1	5	jeed	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:58
S2	378	jet with electroplat\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:58
S3	0	jet with electroplat\$ and nozle	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:58
S4	175	jet with electroplat\$ and nozzle	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:58
S5	118	jet with electroplat\$ and nozzle and @pd<"20021105"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 10:59
S6	31	jet with electroplat\$ and nozzle and @pd<"20021105" and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:00
S7	4	jet with electroplat\$ and nozzle and @pd<"20021105" and (semiconductor wafer microelectronic microfeature) and vibrat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:00
S8	41	electroplat\$ with vibrat\$3 and @pd<"20021105" and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:01

S9	21	electroplat\$ with vibrat\$3 with (ultrasonic megasonic) and @pd<"20021105" and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:24
S10	17	"58182823" "63118093" "1255684" "04131395" "04280993" "6017291"	JPO; DERWENT	OR	ON	2006/02/16 11:22
S11	2	"04131395"	JPO; DERWENT	OR	ON	2006/02/16 11:22
S12	2	"50032047"	JPO; DERWENT	OR	ON	2006/02/16 11:22
S13	7	electrodepos\$ with vibrat\$3 with (ultrasonic megasonic) and @pd<"20021105" and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:27
S14	8	205/148.ccls. and (ultrasonic megasonic) and @pd<"20021105" and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:27
S15	14	cohen-uri\$.in. and (ultrasonic megasonic vibrat\$ oscillat\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:41
S16	2	cohen-uri\$.in. and (ultrasonic megasonic vibrat\$ oscillat\$).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:36
S17	4	cohen-uri\$.in. and (inhibitor adj additive)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:44
S18	26	copper with electroplat\$ with inhibitor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/16 11:46
S19	199	brightener with concentration	US-PGPUB	OR	ON	2006/02/16 11:46
S20	71	brightener with concentration and ("204" "205").clas.	US-PGPUB	OR	ON	2006/02/16 11:46